# EMY1 / UMY1N / FMY1A

Emitter common (dual transistors)

Datasheet

## <For Tr1(PNP)>

Parameter	Value
V <sub>CEO</sub>	-50V
I <sub>C</sub>	-150mA

### <For Tr2(NPN)>

Parameter	Value
V <sub>CEO</sub>	50V
I <sub>C</sub>	150mA

### Outline

SOT-553	SOT-353
(t) (2) (4)	(4)
EMY1	UMY1N
(EMT5)	(UMT5)
SOT-25	
.s: (4)	

# Features

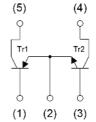
- 1) Included a 2SA1037AK and a 2SC2412K transistor in a EMT, UMT or SMT package.
- 2)Mounting possible with EMT3 or UMT3 or SMT3 automatic mounting machines.
- 3) PNP and NPN transistors have common emitters.
- 4) Mounting cost and area can be cut in half.

### •Inner circuit

### EMY1 / UMY1N

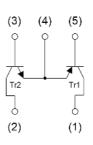
FMY1A (SMT5)

- (1) Tr1 Base
- (2) Tr1/Tr2 Emitter
- (3) Tr2 Base
- (4) Tr2 Collector
- (5) Tr1 Collector



## FMY1A

- (1) Tr1 Collector
- (2) Tr2 Collector
- (3) Tr2 Base
- (4) Tr1/Tr2 Emitter
- (5) Tr1 Base



# Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Quantity (pcs)	Marking
EMY1	SOT-553 (EMT5)	1616	T2R	180	8	8000	Y1
UMY1N	SOT-353 (UMT5)	2021	TR	180	8	3000	Y1
FMY1A	SOT-25 (SMT5)	2928	T148	180	8	3000	Y1

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter			Tr1(PNP)	Tr2(NPN)	Unit
Collector-base voltage			-60	60	V
Collector-emitter voltage			-50	50	V
Emitter-base voltage			-6	7	V
Collector current			-150	150	mA
Device discipation	EMY1/ UMY1N		150		mW/Total
Power dissipation FMY1A		P <sub>D</sub> *1*3	300		mW/Total
Junction temperature			150		°C
Range of storage temperature			-55 to +150		°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C) <For Tr1(PNP)>

, 2	· · · · · ·	,					
Parameter	Symbol	Conditions	Values			Unit	
- alametei	Symbol	Conditions	Min.	Тур.	Max.	Oi iit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -50μA	-60	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-50	-	-	V	
Emitter-base breakdown voltage	$BV_{EBO}$	I <sub>E</sub> = -50μA	-6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -60V	-	-	-100	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V	-	-	-100	nA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$	-	-	-500	mV	
DC current gain	h <sub>FE</sub>	$V_{CE} = -6V, I_{C} = -1mA$	120	-	560	-	
Transition frequency	f⊤	$V_{CE} = -12V, I_{E} = 2mA,$ f = 100MHz	-	140	-	MHz	
Output capacitance	C <sub>ob</sub>	$V_{CB} = -12V, I_E = 0A,$ f = 1MHz	-	4.0	5.0	pF	

# ullet Electrical characteristics (T<sub>a</sub> = 25°C) <For Tr2(NPN)>

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	$BV_{CBO}$	I <sub>C</sub> = 50μA	60	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	-	1	V
Emitter-base breakdown voltage	$BV_{EBO}$	I <sub>E</sub> = 50μA	7	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 60V	-	-	100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 7V	-	-	100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 50$ mA, $I_B = 5$ mA	-	-	400	mV
DC current gain	h <sub>FE</sub>	$V_{CE}$ = 6V, $I_{C}$ = 1mA	120	-	560	-
Transition frequency	f <sub>T</sub>	$V_{CE} = 12V, I_{E} = -2mA,$ f = 100MHz	-	180	-	MHz
Output capacitance	C <sub>ob</sub>	$V_{CB} = 12V$ , $I_E = 0A$ , $f = 1MHz$	-	2.0	3.5	pF

<sup>\*1</sup> Each terminal mounted on a referenve land.



<sup>\*2 120</sup>mW per element must not be exceeded.

<sup>\*3 200</sup>mW per element must not be exceeded.

# ● Electrical characteristic curves(T<sub>a</sub>=25°C) <For Tr1(PNP)>

Fig.1 Ground Emitter Propagation Characteristics

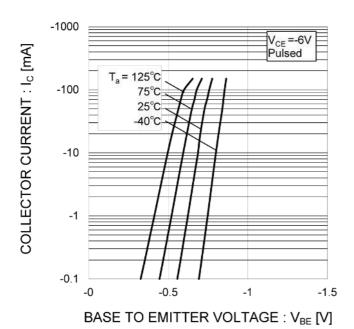
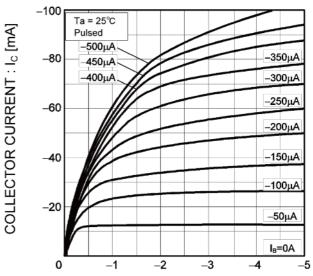


Fig.2 Grounded Emitter Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current (I)

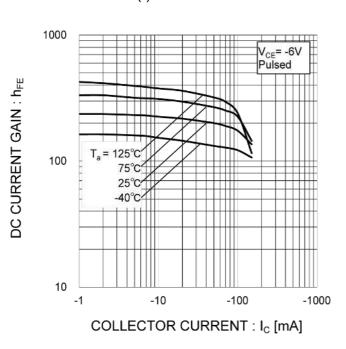
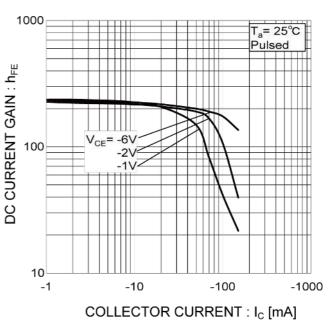
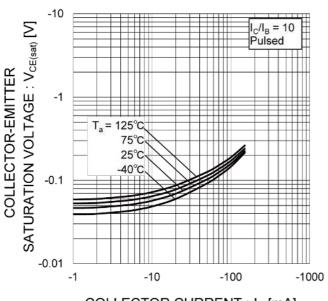


Fig.4 DC Current Gain vs. Collector Current (II)



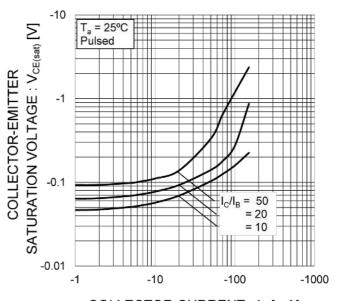
# ● Electrical characteristic curves(T<sub>a</sub>=25°C) <For Tr1(PNP)>

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)



COLLECTOR CURRENT :  $I_C$  [mA]

Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)



COLLECTOR CURRENT : I<sub>C</sub> [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current (I)

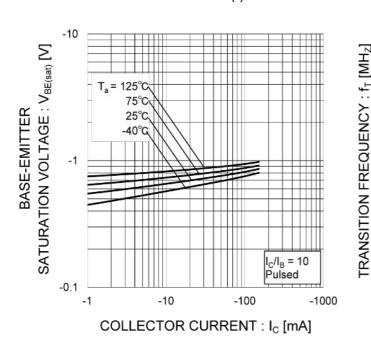
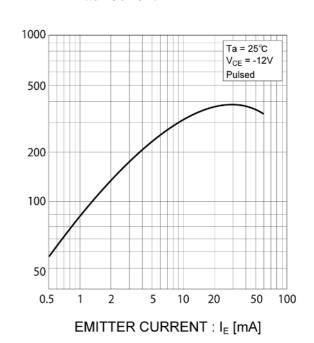


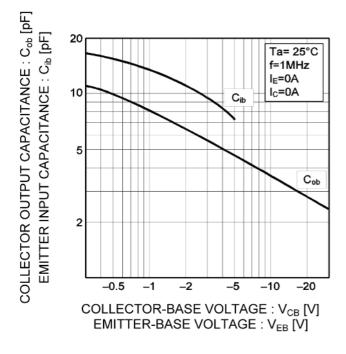
Fig.8 Gain Bandwith Product vs.
Emitter Current



# ● Electrical characteristic curves(T<sub>a</sub>=25°C) <For Tr1(PNP)>

Fig.9 Collector Output Capacitance vs. ollector-Base Voltage Emitter Input Capacitance vs. Emitter-Base Voltage

Fig.10 Safe Operating Area



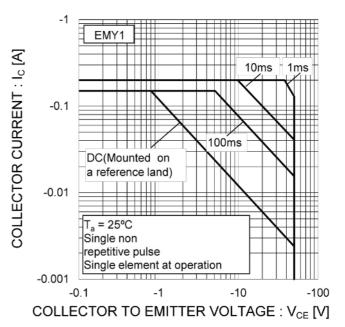


Fig.11 Safe Operating Area

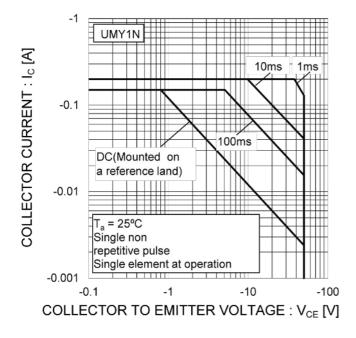
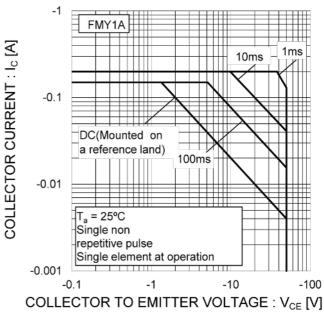
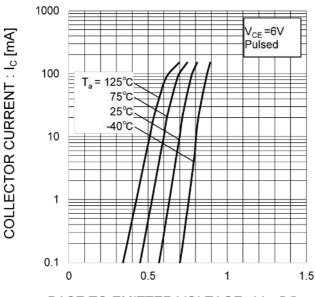


Fig.12 Safe Operating Area



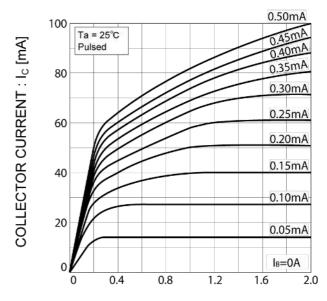
# ● Electrical characteristic curves(T<sub>a</sub>=25°C) <For Tr2(NPN)>

Fig.13 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE: V<sub>BE</sub> [V]

Fig.14 Grounded Emitter Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.15 DC Current Gain vs. Collector Current (I)

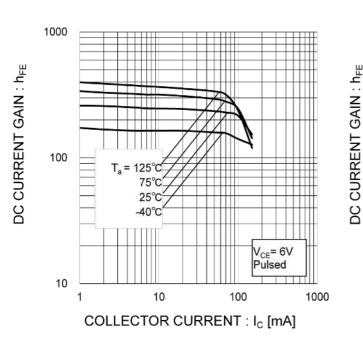
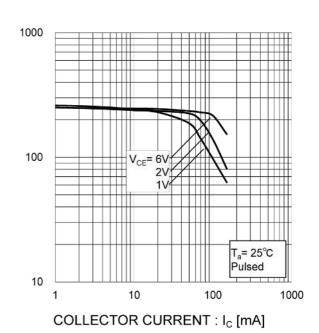


Fig.16 DC Current Gain vs. Collector Current (II)



# ● Electrical characteristic curves (T<sub>a</sub> = 25°C) < For Tr2(NPN)>

Fig.17 Collector-Emitter Saturation Voltage vs. Collector Current(I)

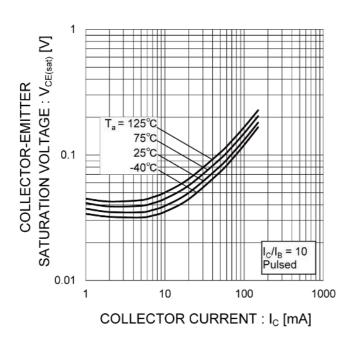


Fig.18 Collector-Emitter Saturation Voltage vs. Collector Current(II)

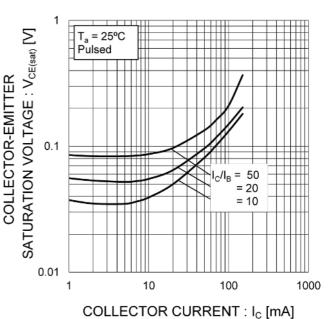


Fig.19 Base-Emitter Saturation Voltage vs. Collector Current (I)

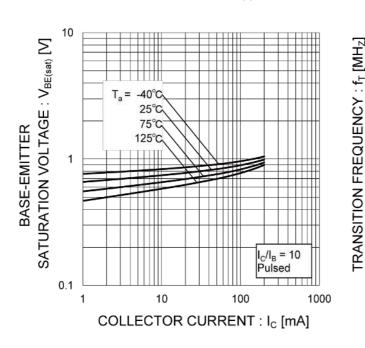
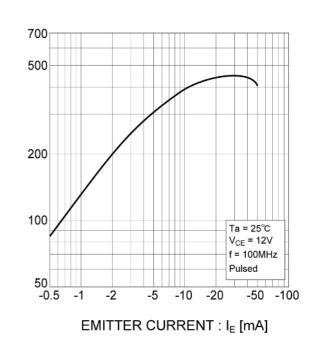


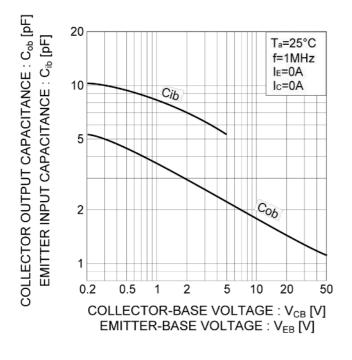
Fig.20 Gain Bandwith Product vs. Emitter Current



# ● Electrical characteristic curves(T<sub>a</sub> = 25°C) < For TR2(NPN)>

Fig.21 Collector Output Capacitance vs. ollector-Base Voltage
Emitter Input Capacitance vs.
Emitter-Base Voltage

Fig.22 Safe Operating Area



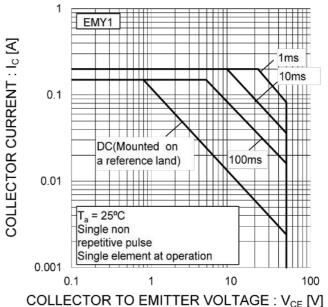


Fig.23 Safe Operating Area

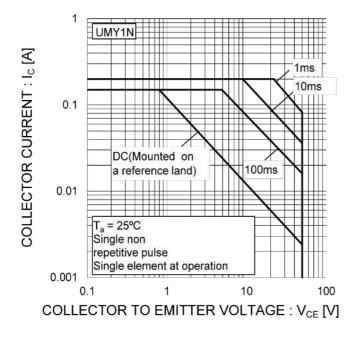
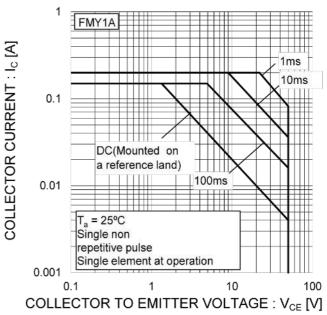
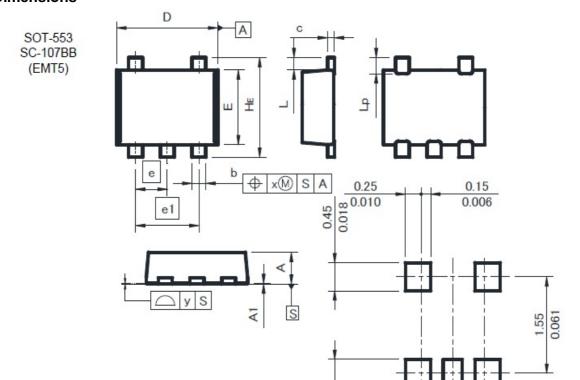


Fig.24 Safe Operating Area



# Dimensions



0.006 0.010

Soldering footprint

Unit: (mm/inches)

0.50

0.020

0.25

			100		
DIM	Millim	neters	Inches		
DIIVI	Min.	Max.	Min.	Max.	
Α	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
С	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.5	50	0.020		
e1	1.0	00	0.0	39	
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	<u> </u>	0.35	12	0.014	
X	J=1	0.10	-	0.004	
V	-	0.10	-	0.004	

0.50

0.020

0.30

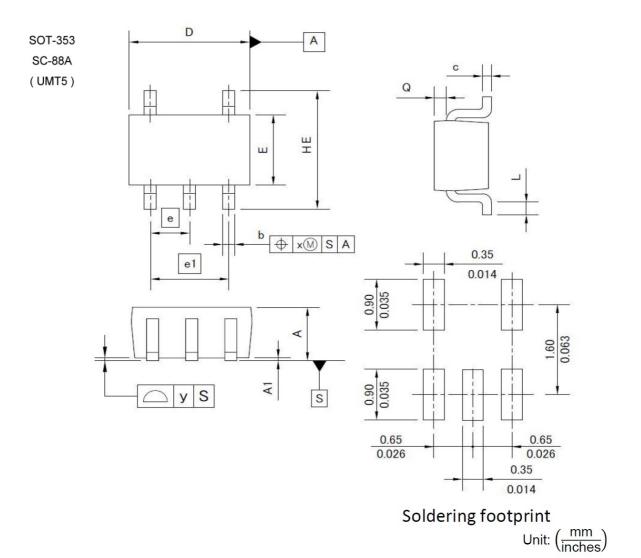
0.15

0.45

Dimension in mm / inches



## Dimensions

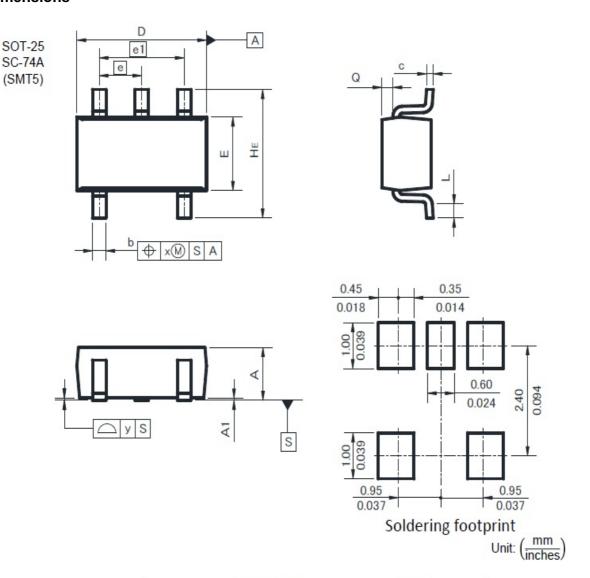


DIM	Millimeters		Inches		
DIIVI	Min.	Max.	Min.	Max.	
Α	0.80	1.10	0.031	0.043	
A1	0.00	0.10	0.000	0.004	
b	0.15	0.30	0.006	0.012	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.0	35	5 0.02		
e1	1.3	30	0.051		
HE	2.00	2.20	0.079	0.087	
L	0.10	0.40	0.004	0.016	
Q	0.10	0.30	0.004	0.012	
Х		0.10	_	0.004	
У	-	0.10	4	0.004	

Dimension in mm / inches



# Dimensions



DIM	Millin	neters	Inc	hes
DIIVI	Min.	Max.	Min.	Max.
Α	1.00	1.40	0.039	0.055
A1	0.00	0.10	0.000	0.004
b	0.25	0.40	0.010	0.016
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.037	
e1	1.9	90	0.075	
HE	2.60	3.00	0.102	0.118
L	0.30	0.60	0.012	0.024
Q	0.20	0.50	0.008	0.020
X	-	0.20	-	0.008
У	_	0.10	-	0.004

Dimension in mm / inches

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Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCTI	CLASS II b	СГУССШ
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

### **Precaution for Product Label**

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